Declaration and Power of Attorney For Patent Application English Language Declaration

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

METHOD	OF	ISSUING MAI	L ADDRESS	AND	SYSTEM	FOR	DOING	THE	SAME	;
the specification of which										
(check one)										
☐ is attached hereto.										
was filed ona										
Application Serial No.										
and was amended on										
	(if applicable)									
I hereby state that I have reviewed and understand the contents of the above identified specification including the claims, as amended by any amendment referred to above.										
I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56(a).										
I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below an foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:										
Prior Foreign Application(s) <u>Priority</u>							riority C	Claimed		
343503/2	2002	Japan	2	7/11/	2002			F	ਰਾ	
(Number)		(Country)			ear Filed)			Y	X] es	No
(Number)		(Country)	(Day/l	Month/\	ear Filed)		······	[Y	es	No
(Number)		(Country)	(Day/l	Month/	ear Filed)		· · · · · · · · · · · · · · · · · · ·	Ý	_ es	No
I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s										

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56(a) which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

Form PTO-FB-110 (8-83)

Patent and Trademark Office-U.S. DEPARTMENT OF COMMERC

(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
(Application Serial No.)	(Filing Date)	(Status) (patented, pending, abandoned)
statements made on information and were made with the knowledge that by fine or imprisonment, or both, und	belief are believed to be willful false statements der Section 1001 of Title	own knowledge are true and that all true; and further that these statements and the like so made are punishable 18 of the United States Code and that the application or any patent issued
to prosecute this application and tran therewith. Charles A. Laff (19787); J.	isact all business in the F Warren Whitesel (16830); 674); Martin L. Stern (289	ne following attorney(s) and/or agents(s) Patent and Trademark Office connected Robert F. I. Conte (20354); Howard B. (11); Bernard L. Kleinke (22123); Louis (27479).
Send Correspondence to: LAFF, WHI Illinois 60611.	TESEL, CONTE & SARET	, 401 North Michigan Avenue, Chicago,
Direct Telephone Calls to: at telephone No. (312) 661-2100. Full name of sole or first inventor SHINTARO SUZUKI Inventor's signature Mintaro Residence Tokyo, Japan Citizenship Japanese Post Office Address		November 19, 2003
c/o NEC Corporation, 7-1, Sh	iba 5-chome, Minato-	ku, Tokyo, Japan
Full name of second joint inventor, if any TAKESHI FUKUIZUMI Second Inventor's signature Residence Tokyo, Japan	<u>(a)</u>	November 19, 2003
Citizenship Japanese Post Office Address		
c/o NEC Corporation, 7-1, Sh	iba 5-chome, Minato-	ku, Tokyo, Japan
(Supply similar information and s	signature for third and	subsequent joint inventors)